

Title (en)  
ZINC OR ZINC ALLOY ELECTROPLATING METHOD AND SYSTEM

Title (de)  
ZINK- ODER ZINKLEGIERUNGEN ELEKTROPLIERMETHODE UND -SYSTEM

Title (fr)  
PROCÉDÉ ET SYSTÈME D'ÉLECTRODÉPOSITION DE ZINC OU D'ALLIAGE DE ZINC

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Application  
**EP 19766159 A 20190215**

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Abstract (en)  
The present invention provides a zinc or zinc alloy electroplating method comprising: performing energizing in an alkaline zinc or zinc alloy electroplating bath provided with a cathode and an anode, wherein the anode is an anode in which a conductive substrate is coated in a conductive state with alkali-resistant ceramics, the alkaline zinc or zinc alloy electroplating bath is an alkaline zinc plating bath containing an organic compound additive or an alkaline zinc alloy electroplating bath containing an amine chelating agent or an organic compound additive, oxidation decomposition, on a surface of the anode caused by the energizing, of the organic compound additive in the alkaline zinc plating bath or the amine chelating agent and the organic compound additive in the alkaline zinc alloy electroplating bath is suppressed as compared with a case of using as an anode the same conductive substrate uncoated with the alkali-resistant ceramics.

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